

General purpose JFET quad operational amplifier

Features

- Wide common-mode (up to V_{CC}^+) and differential voltage range
- Low input bias and offset current
- Output short-circuit protection
- High input impedance JFET input stage
- Internal frequency compensation
- Latch up free operation
- High slew rate: 16V/ μ s (typ)

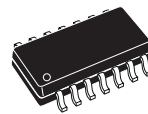
Description

The TL084, TL084A and TL084B are high-speed JFET input quad operational amplifiers incorporating well matched, high voltage JFET and bipolar transistors in a monolithic integrated circuit.

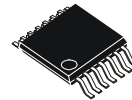
The devices feature high slew rates, low input bias and offset currents, and low offset voltage temperature coefficient.



N
DIP14
(Plastic package)



D
TSSOP-14
(Thin shrink small outline package)



D
SO-14
(Plastic micropackage)

Pin connections (Top view)

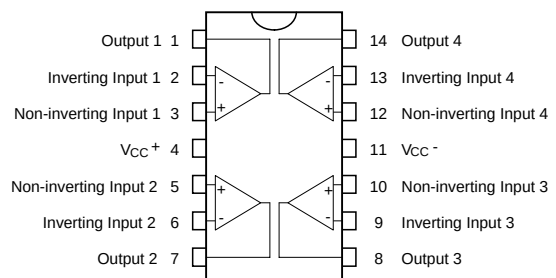
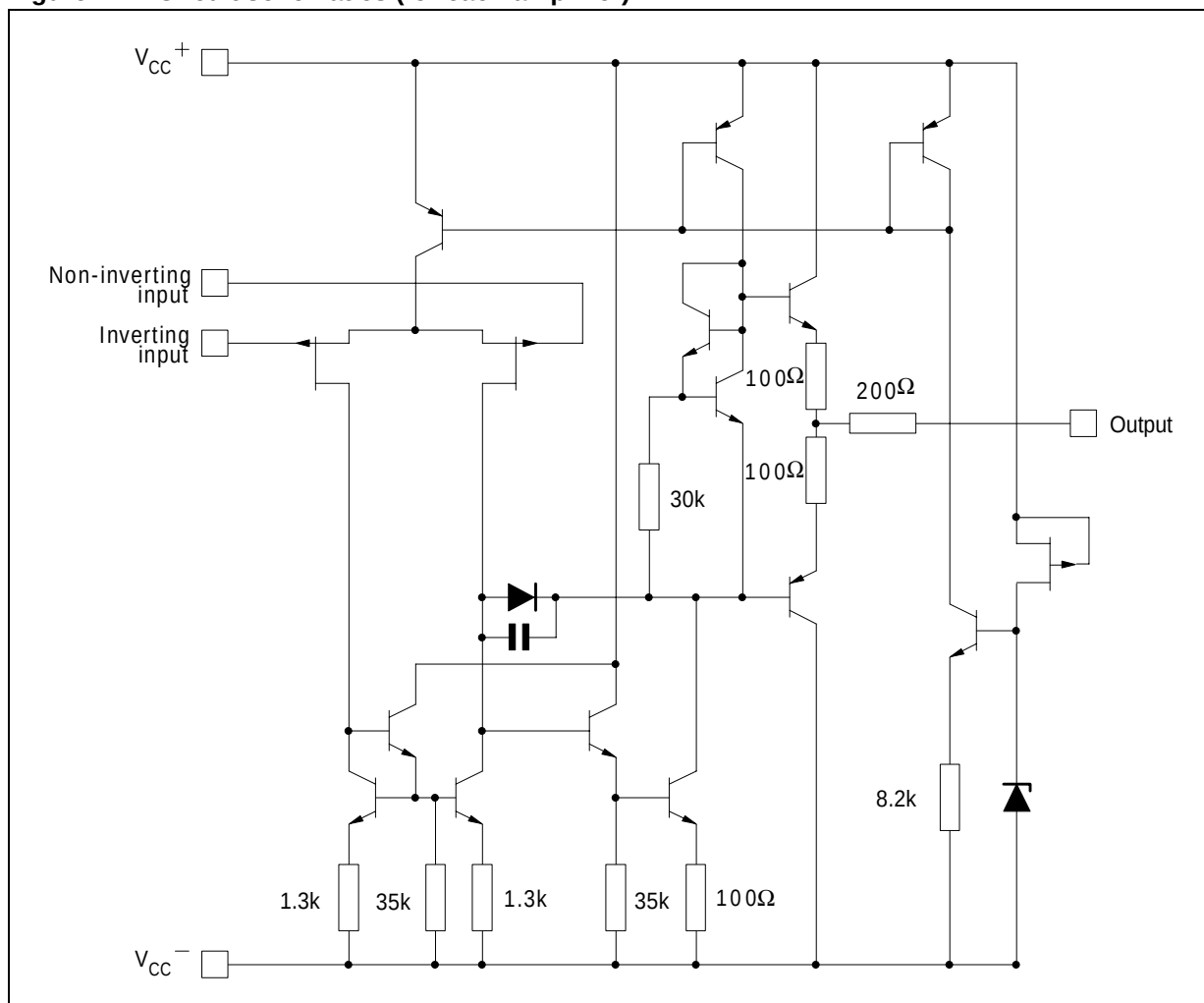


Figure 1. Circuit schematics (for each amplifier)



2 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	Value			Unit
		TL084M, AM, BM	TL084I, AI, BI	TL084C, AC, BC	
V _{CC}	Supply voltage ⁽¹⁾	±18			V
V _i	Input voltage ⁽²⁾	±15			V
V _{id}	Differential input voltage ⁽³⁾	±30			V
R _{thja}	Thermal resistance junction to ambient ^{(4) (5)}				°C/W
	SO-14	105			
	DIP14	80			
	TSSOP14	100			
R _{thjc}	Thermal resistance junction to case ^{(4) (5)}				°C/W
	SO-14	31			
	DIP14	33			
	TSSOP14	32			
P _{tot}	Power dissipation	680			mW
	Output short-circuit duration ⁽⁶⁾	Infinite			
T _{oper}	Operating free-air temperature range	-55 to +125	-40 to +105	0 to +70	°C
T _{stg}	Storage temperature range	-65 to +150			°C
ESD	HBM: human body model ⁽⁷⁾	1000			V
	MM: machine model ⁽⁸⁾	150			
	CDM: charged device model ⁽⁹⁾	1500			

1. All voltage values, except differential voltage, are with respect to the zero reference level (ground) of the supply voltages where the zero reference level is the midpoint between V_{CC}^+ and V_{CC}^- .
2. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 volts, whichever is less.
3. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
4. Short-circuits can cause excessive heating and destructive dissipation.
5. R_{th} are typical values.
6. The output may be shorted to ground or to either supply. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.
7. Human body model: 100pF discharged through a 1.5k Ω resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
8. Machine model: a 200pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω), done for all couples of pin combinations with other pins floating.
9. Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.

Table 2. Operating conditions

Symbol	Parameter	TL084M, AM, BM	TL084I, AI, BI	TL084C, AC, BC	Unit
V_{CC}	Supply voltage range	6 to 36			V
T_{oper}	Operating free-air temperature range	-55 to +125	-40 to +105	0 to +70	°C

3 Electrical characteristics

Table 3. $V_{CC} = \pm 15V$, $T_{amb} = +25^{\circ}C$ (unless otherwise specified)

Symbol	Parameter	TL084I,M,AC,AI,AM,BC,BI,BM			TL084C			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
V_{io}	Input offset voltage ($R_S = 50\Omega$) $T_{amb} = +25^{\circ}C$ TL084 TL084A TL084B $T_{min} \leq T_{amb} \leq T_{max}$ TL084 TL084A TL084B		3 3 1	10 6 3 13 7 5		3	10 13	mV
DV_{io}	Input offset voltage drift		10			10		$\mu V/^{\circ}C$
I_{io}	Input offset current $T_{amb} = +25^{\circ}C$ $T_{min} \leq T_{amb} \leq T_{max}$		5	100 4		5	100 4	pA nA
I_{ib}	Input bias current ⁽¹⁾ $T_{amb} = +25^{\circ}C$ $T_{min} \leq T_{amb} \leq T_{max}$		20	200 20		30	200 20	pA nA
A_{vd}	Large signal voltage gain ($R_L = 2k\Omega$, $V_o = \pm 10V$) $T_{amb} = +25^{\circ}C$ $T_{min} \leq T_{amb} \leq T_{max}$	50 25	200		25 15	200		V/mV
SVR	Supply voltage rejection ratio ($R_S = 50\Omega$) $T_{amb} = +25^{\circ}C$ $T_{min} \leq T_{amb} \leq T_{max}$	80 80	86		70 70	86		dB
I_{CC}	Supply current, no load $T_{amb} = +25^{\circ}C$ $T_{min} \leq T_{amb} \leq T_{max}$		1.4	2.5 2.5		1.4	2.5 2.5	mA
V_{icm}	Input common mode voltage range	± 11	+15 -12		± 11	+15 -12		V
CMR	Common mode rejection ratio ($R_S = 50\Omega$) $T_{amb} = +25^{\circ}C$ $T_{min} \leq T_{amb} \leq T_{max}$	80 80	86		70 70	86		dB
I_{os}	Output short-circuit current $T_{amb} = +25^{\circ}C$ $T_{min} \leq T_{amb} \leq T_{max}$	10 10	40	60 60	10 10	40	60 60	mA
$\pm V_{opp}$	Output voltage swing $T_{amb} = +25^{\circ}C$ $R_L = 2k\Omega$ $R_L = 10k\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$ $R_L = 2k\Omega$ $R_L = 10k\Omega$	10 12 10 12	12 13.5		10 12 10 12	12 13.5		V
SR	Slew rate ($T_{amb} = +25^{\circ}C$) $V_{in} = 10V$, $R_L = 2k\Omega$, $C_L = 100pF$, unity gain	8	16		8	16		V/ μs

Table 3. $V_{CC} = \pm 15V$, $T_{amb} = +25^{\circ}C$ (unless otherwise specified) (continued)

Symbol	Parameter	TL084I,M,AC,AI,AM, BC,BI,BM			TL084C			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
t_r	Rise time ($T_{amb} = +25^{\circ}C$) $V_{in} = 20mV$, $R_L = 2k\Omega$, $C_L = 100pF$, unity gain		0.1			0.1		μs
K_{ov}	Overshoot ($T_{amb} = +25^{\circ}C$) $V_{in} = 20mV$, $R_L = 2k\Omega$, $C_L = 100pF$, unity gain		10			10		%
GBP	Gain bandwidth product ($T_{amb} = +25^{\circ}C$) $V_{in} = 10mV$, $R_L = 2k\Omega$, $C_L = 100pF$, $f = 100kHz$	2.5	4		2.5	4		MHz
R_i	Input resistance		10^{12}			10^{12}		Ω
THD	Total harmonic distortion ($T_{amb} = +25^{\circ}C$, $f = 1kHz$, $R_L = 2k\Omega$, $C_L = 100pF$, $A_v = 20dB$, $V_o = 2V_{pp}$)		0.01			0.01		%
e_n	Equivalent input noise voltage $R_S = 100\Omega$, $f = 1kHz$		15			15		$\frac{nV}{\sqrt{Hz}}$
ϕ_m	Phase margin		45			45		degrees
V_{o1}/V_{o2}	Channel separation $A_v = 100$		120			120		dB

1. The input bias currents are junction leakage currents which approximately double for every $10^{\circ}C$ increase in the junction temperature.

Figure 2. Maximum peak-to-peak output voltage versus frequency

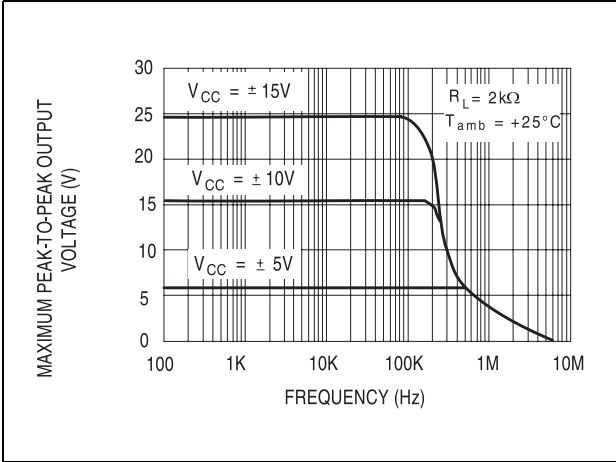


Figure 3. Maximum peak-to-peak output voltage versus frequency

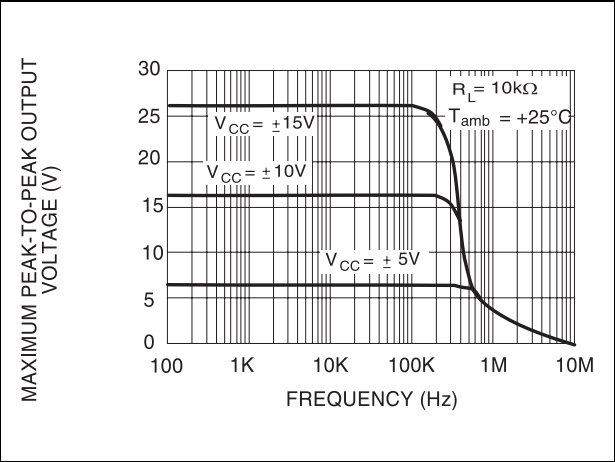


Figure 4. Maximum peak-to-peak output voltage versus frequency

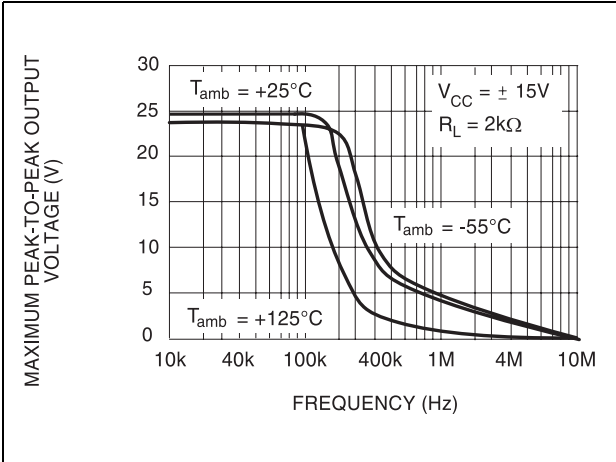


Figure 5. Maximum peak-to-peak output voltage versus free air temperature

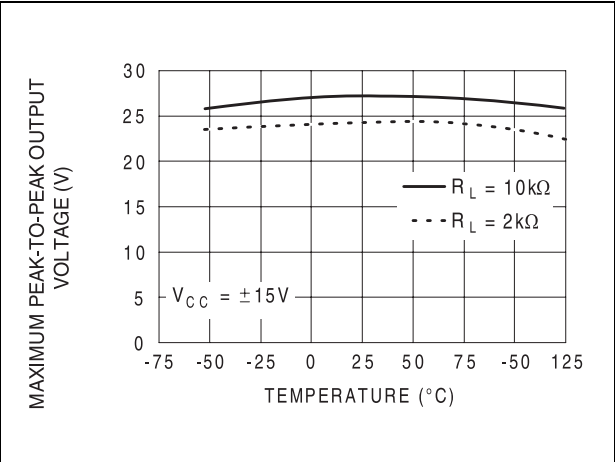


Figure 6. Maximum peak-to-peak output voltage versus load resistance

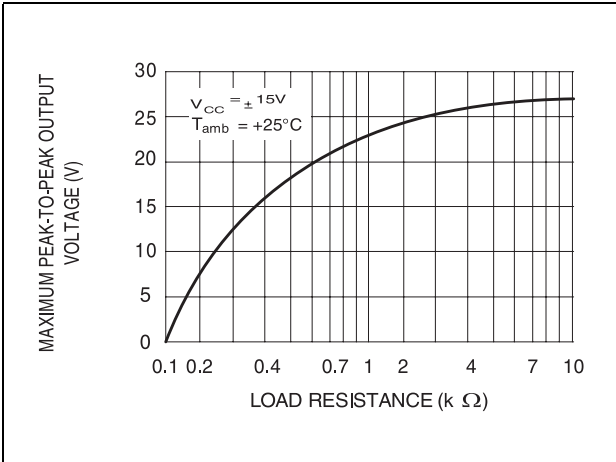


Figure 7. Maximum peak-to-peak output voltage versus supply voltage

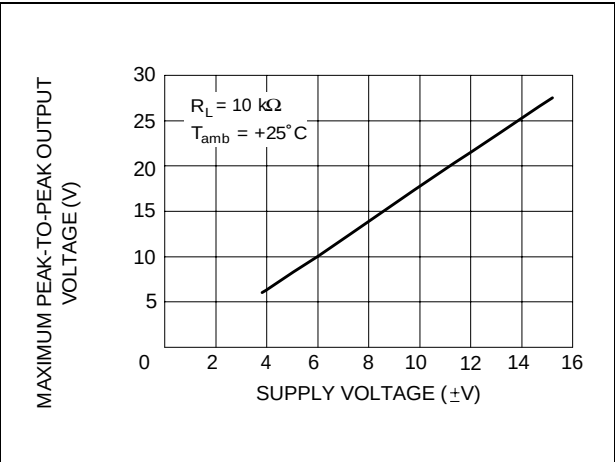


Figure 8. Input bias current versus free air temperature

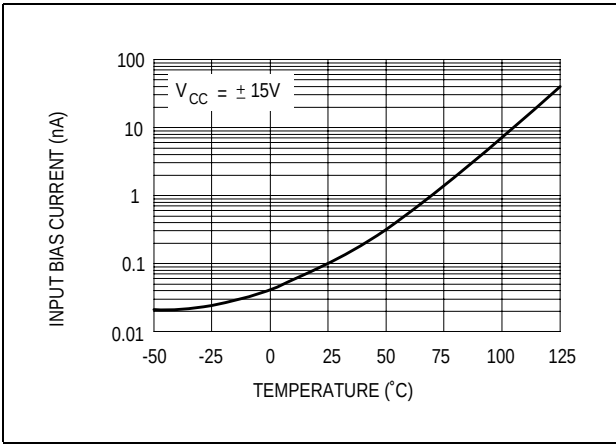


Figure 9. Large signal differential voltage amplification versus free air temperature

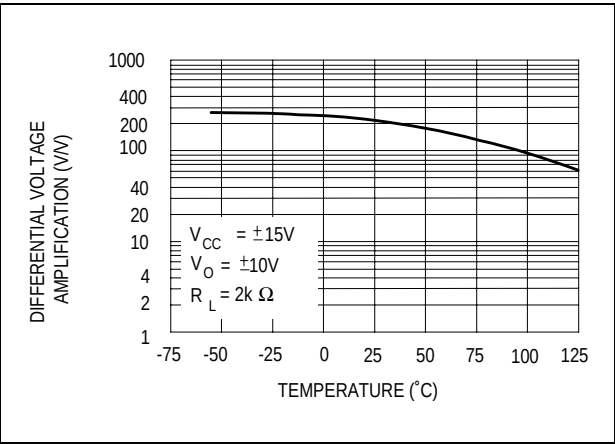


Figure 10. Large signal differential voltage amplification and phase shift versus frequency

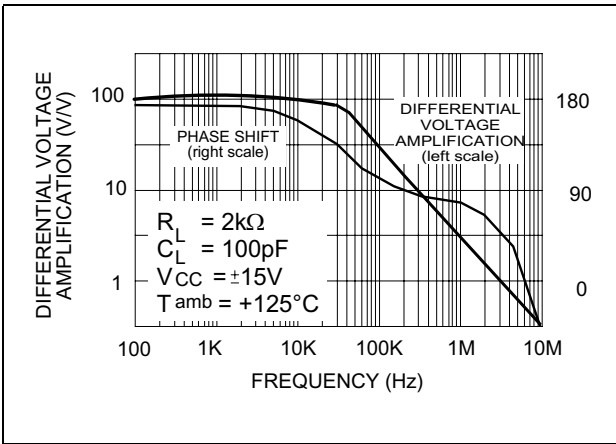


Figure 11. Total power dissipation versus free air temperature

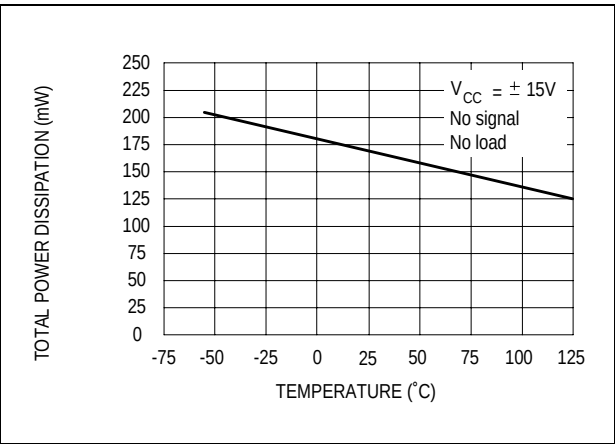


Figure 12. Supply current per amplifier versus free air temperature

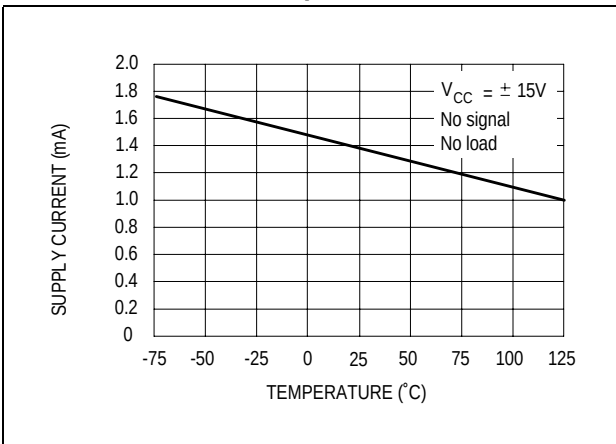


Figure 13. Supply current per amplifier versus supply voltage

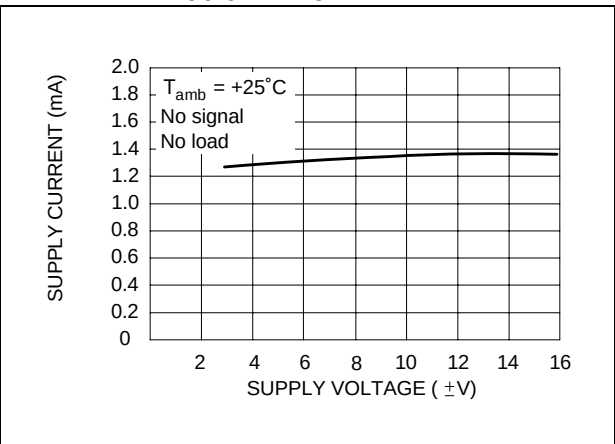


Figure 14. Common mode rejection ratio versus free air temperature

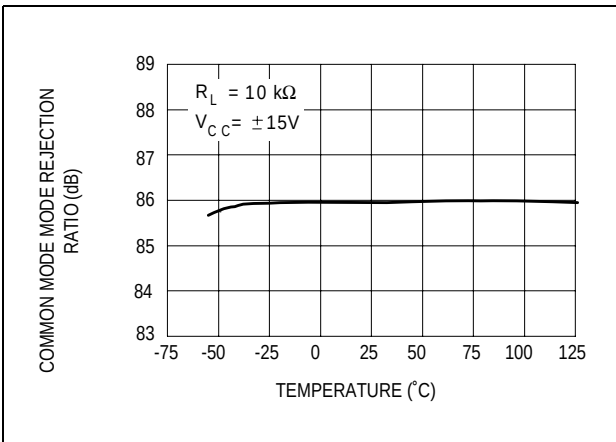


Figure 15. Voltage follower large signal pulse response

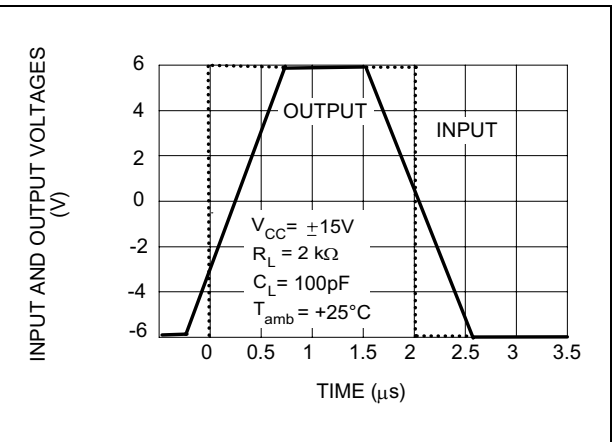


Figure 16. Output voltage versus elapsed time

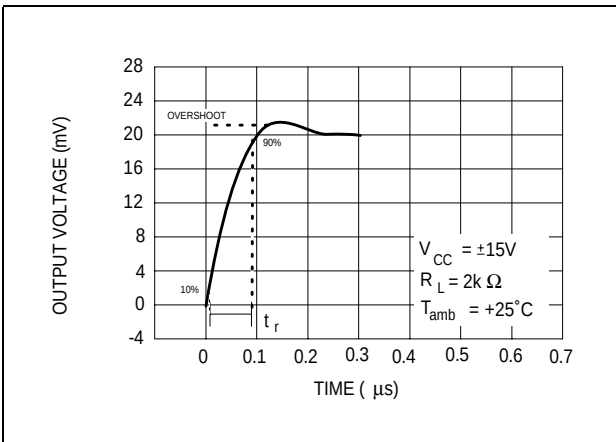


Figure 17. Equivalent input noise voltage versus frequency

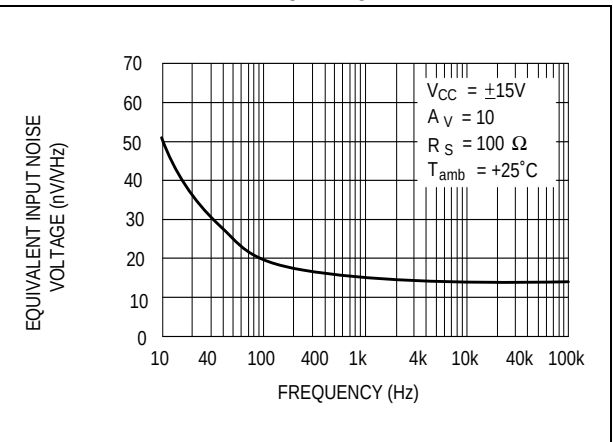
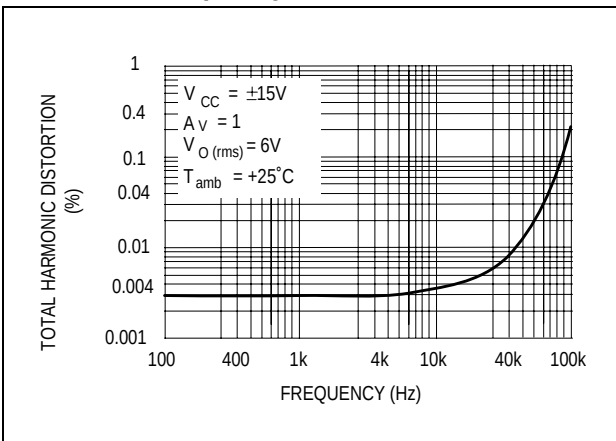


Figure 18. Total harmonic distortion versus frequency



Parameter measurement information

Figure 19. Voltage follower

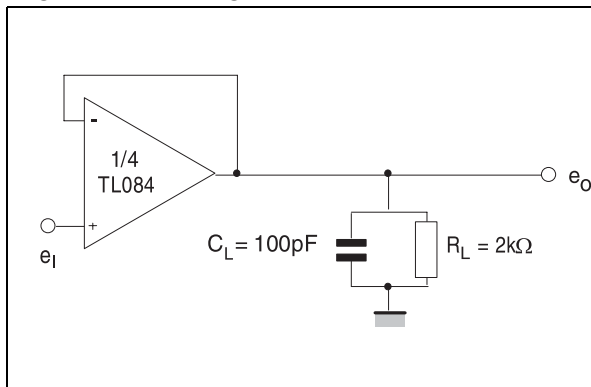
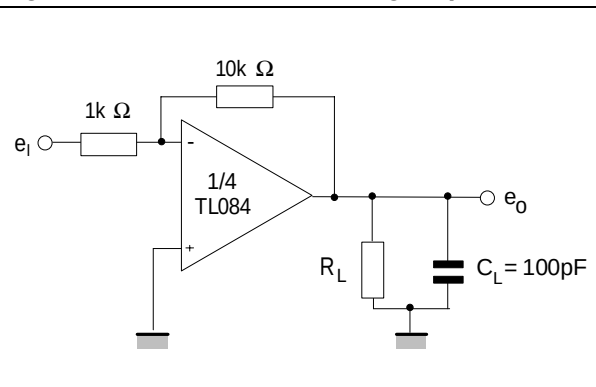


Figure 20. Gain-of-10 inverting amplifier



4 Typical applications

Figure 21. Audio distribution amplifier

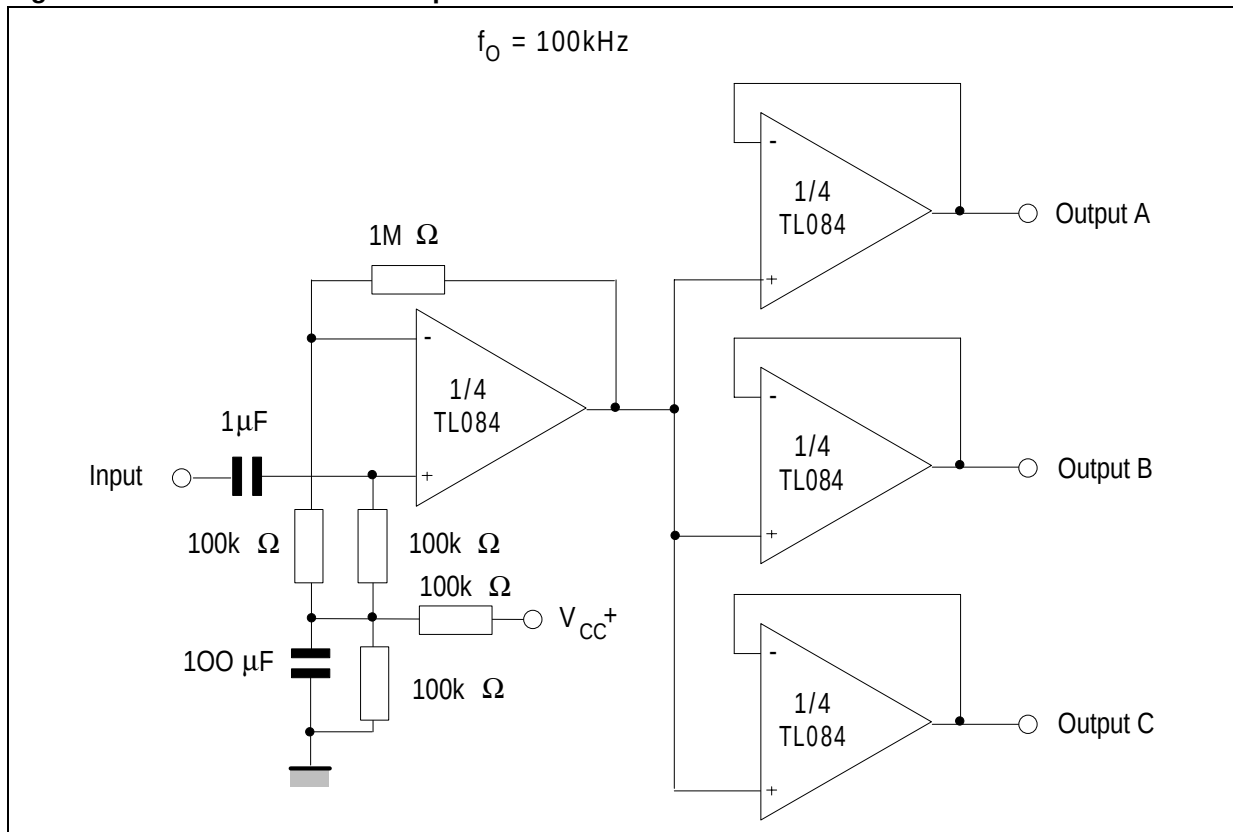


Figure 22. Positive feedback bandpass filter

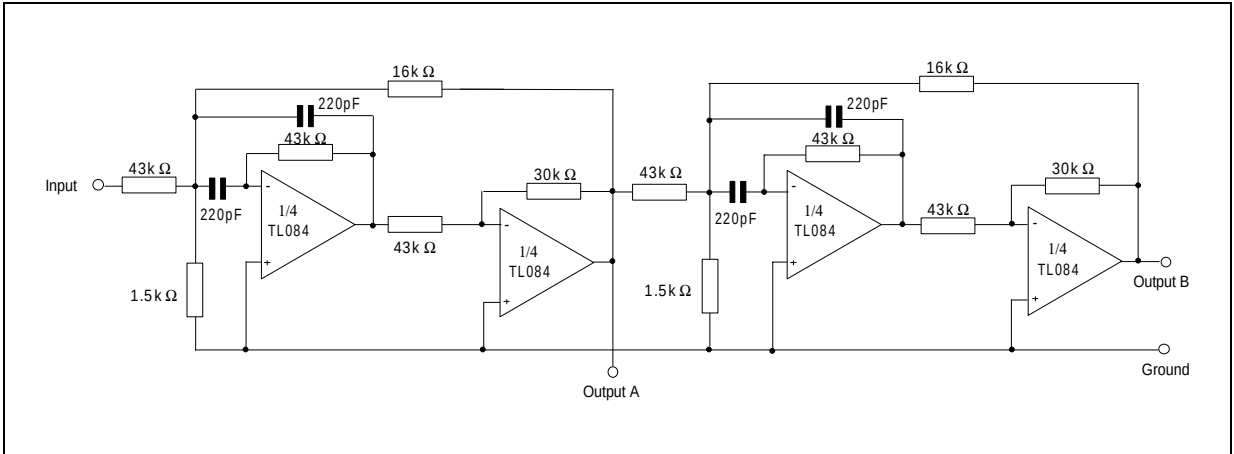


Figure 23. Output A

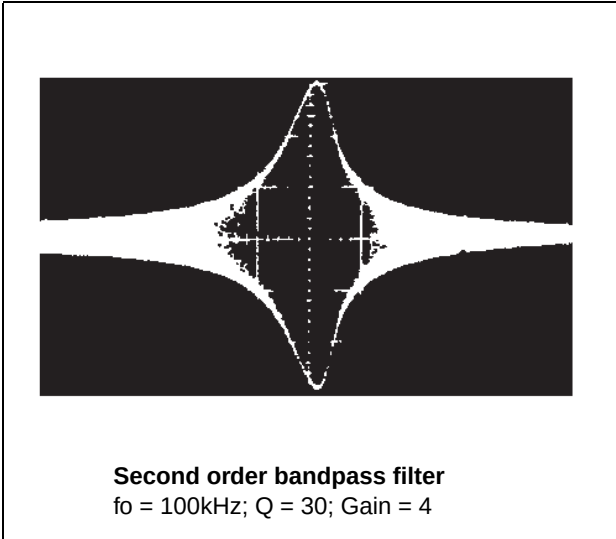
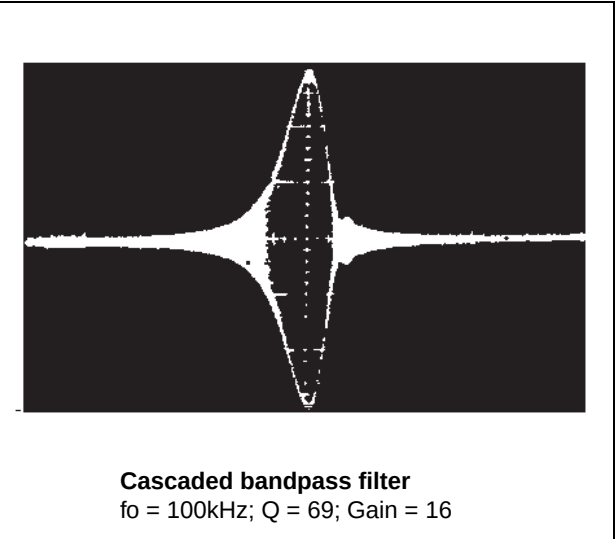


Figure 24. Output B



5 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Figure 25. TSSOP14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030

The figure includes three mechanical drawings of the TSSOP14 package. The top-left drawing is a side view showing dimensions A (total height), A1 (lead height), A2 (body height), b (lead width), e (pitch), and c (lead thickness). The top-right drawing is a cross-sectional view showing dimensions K (lead angle), L (lead thickness), and E (body width). The bottom drawing is a top view showing dimensions D (body length), E1 (body width), and a pin 1 identification circle with the number 1.

Figure 26. DIP14 package mechanical data

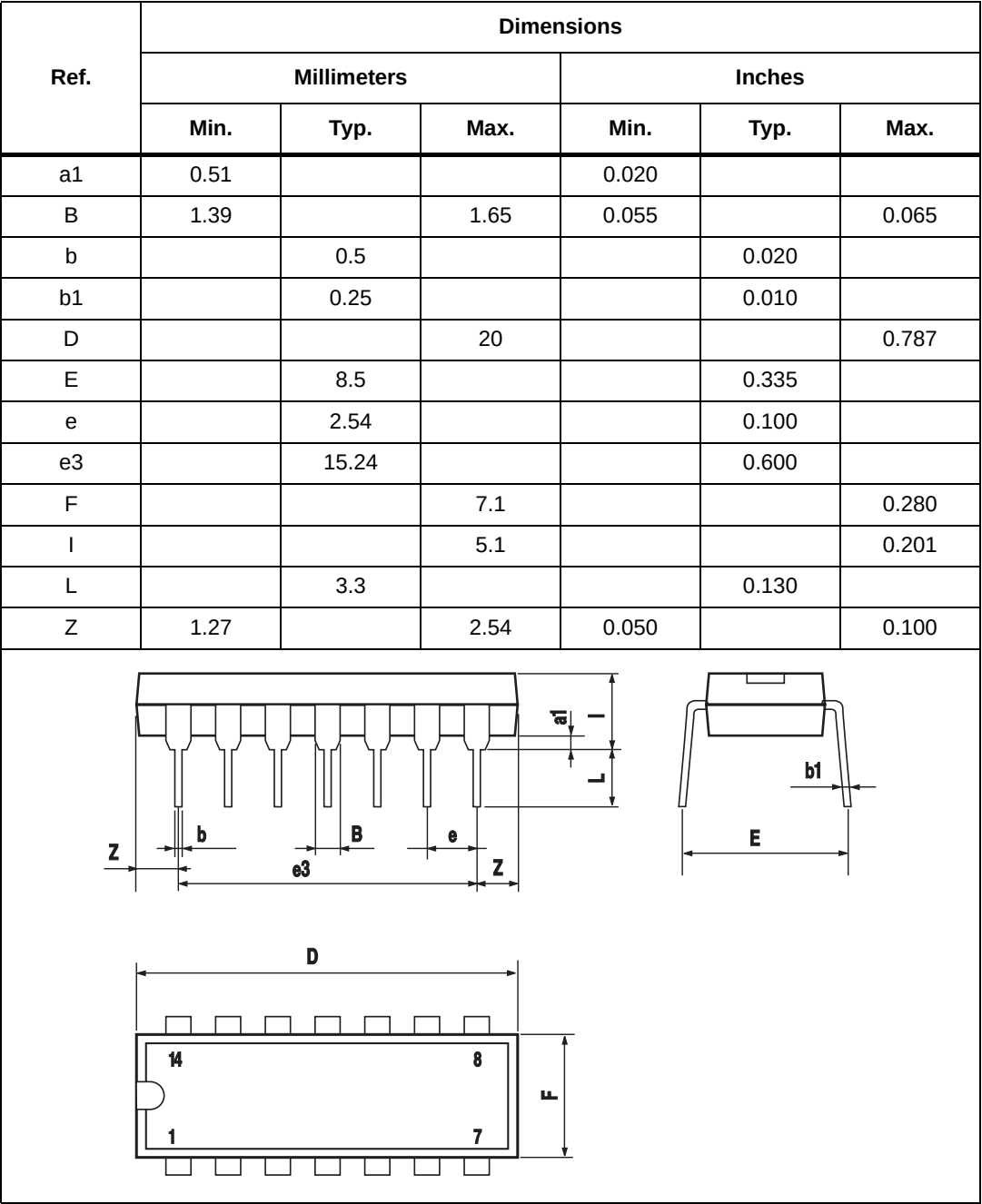


Figure 27. SO-14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S	8° (max.)					

The figure contains three mechanical drawings of the SO-14 package. The top-left drawing is a side view showing the package profile with dimensions A (total height), a2 (lead height), b (lead thickness), e (pitch), e3 (total width), and b1 (lead width). The top-right drawing is a cross-sectional view showing the package body with dimensions L (lead length), G (body length), C (body width), c1 (lead angle), a1 (body height), and b1 (lead width). The bottom drawing is a top-down perspective view showing the package footprint with dimensions D (total width), M (lead spacing), and L (package length), and pin numbers 1, 7, 8, and 14.

6 Ordering information

Table 4. Order codes

Part number	Temperature range	Package	Packing	Marking
TL084MN TL084AMN TL084BMN	-55°C, +125°C	DIP14	Tube	TL084MN TL084AMN TL084BMN
TL084MD/MDT TL084AMD/AMDT TL084BMD/BMDT		SO-14	Tube or tape & reel	084M 084AM 084BM
TL084MP/MPT TL084AMP/AMPT TL084BMP/BMPT		TSSOP14	Tube or tape & reel	084M 084AM 084BM
TL084IN TL084AIN TL084BIN	-40°C, +105°C	DIP14	Tube	TL084IN TL084AIN TL084BIN
TL084ID/IDT TL084AID/AIDT TL084BID/BIDT		SO-14	Tube or tape & reel	084I 084AI 084BI
TL084IP/IPT TL084AIP/AIPT TL084BIP/BIPT		TSSOP14	Tube or tape & reel	084I 084AI 084BI
TL084CN TL084ACN TL084BCN	0°C, +70°C	DIP14	Tube	TL084CN TL084ACN TL084BCN
TL084CD/CDT TL084ACD/ACDT TL084BCD/BCDT		SO-14	Tube or tape & reel	084C 084AC 084BC
TL084CP/CPT TL084ACP/ACPT TL084BCP/BCPT		TSSOP14	Tube or tape & reel	084C 084AC 084BC

7 Revision history

Table 5. Document revision history

Date	Revision	Changes
28-Mar-2001	1	Initial release.
30-Jul-2007	2	Added values for R_{thja} , R_{thjc} and ESD in Table 1: Absolute maximum ratings . Added Table 2: Operating conditions . Expanded Table 4: Order codes . Template update.

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